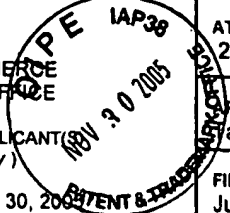


JCTIS Rec'd PCT/PTO 20 APR 2005

| Sheet 1 of 1 FORM PTO 1449 (modified) U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE LIST OF REFERENCES CITED BY APPLICANT(S) (Use several sheets if necessary) Date Submitted to PTO: April 20, 2005 | | INFORMATION DISCLOSURE STATEMENT ATTY DOCKET NO. 2005_0661A SERIAL NO. NEW 10/532139 APPLICANT Tadaharu YOKOKAWA et al. FILING DATE April 20, 2005 GROUP | | | | |
|--|-----------------|---|---------|----------------------------|----------|----------------------------|
| U.S. PATENT DOCUMENTS | | | | | | |
| EXAMINER INITIAL | DOCUMENT NUMBER | DATE | NAME | CLASS | SUBCLASS | FILING DATE IF APPROPRIATE |
| | AA | | | | | |
| | AB | | | | | |
| | AC | | | | | |
| | AD | | | | | |
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| | AG | | | | | |
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| | AI | | | | | |
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| | AQ | | | | | |
| EXAMINER /Nithya Janakiraman/ | | | | DATE CONSIDERED 01/15/2007 | | |

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| Sheet 1 of 1 | | INFORMATION DISCLOSURE STATEMENT | | | | | |
|---|----|---|---------|-------------------------------|-------|--------------------------|-------------------------------|
| FORM PTO, 1449 (modified) U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE LIST OF REFERENCES CITED BY APPLICANT (Use several sheets if necessary) Date Submitted to PTO: November 30, 2005 | |  | | ATTY DOCKET NO. 2005_0661A | | SERIAL NO. 10/532,139 | |
| APPLICANT Tadaharu YOKOKAWA et al. | | | | FILING DATE June 23, 2005 | | GROUP 1742 | |
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